| ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® Internation | al Composition D ight 2005. IPC, Bannoc onal and Pan-American | eclaration kburn, Illinois. A copyright conver | ll rights reserved untions. | Inder both This d | ocument parts, the | t is a declaratio declaration en | n of the substand compasses all lo | es within the n wer level mate | nanufacture rials for whi | er listed item ich the manu | Note: if | the item is an as has engineering | sembly with low responsibility. |
|---|--|--|--------------------------------|--------------------|---|--------------------------------------|---------------------------------------|-----------------------------------|---------------------------------|--------------------------------|----------|-----------------------------------|---------------------------------|
| 759_91 1 1= = | IPC Web Site for Information on IPC-1752 Standard Form The strike Distribution of the strike Standard Distribution of the strike Standard Standar | | | | e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater | | | | ous Material | ials and Mfg Information | | | |
| upplier Information | | | | | | | | | | | | | |
| ompany name* | Company un | Company unique ID | | | Unique ID Authority | | | | Response Date* | | | | |
| nsemi | | | | | | | | | 2025-07-13 | | | | |
| ontact Name | Title - Conta | Title - Contact | | | Phone - Contact* | | | | Email - Contact* | | | | |
| Product-Env-Stewards | Product Envi | Product Enviro Compliance | | | NA | | | | Product-Env-Stewards@onsemi.com | | | | |
| uthorized Representative* | Title - Repres | Title - Representative | | | Phone - Representative* | | | Email - Representative* | | | | | |
| roduct-Env-Stewards | Product Envi | Product Enviro Compliance | | | NA | | | | Product-Env-Stewards@onsemi.com | | | | |
| Requester Item Num | ber Mfr Ite | m Number | Number Mfr Item Name | | E | Effective Date Version Manufacturing | | ng Site | Wei | ght* | UOM | Unit Type | |
| | | NXH200T120H3Q2F2 80kW Gen-II Q2 STNG TIM(Ni-plated) | | PACK-200A Module v | vith 2 | 025-07-13 | 7-13 CNG | | | 175 | 518.11 | mg | Each |
| Ianufacturing Proccess | Information | | | | | | | | | | | | |
| Terminal Plating / Gri | Terminal Plating / Grid Array Material Te | | erminal Base Alloy J-STD-020 M | | g | Peak Process Body Temperat | | ture Max Time at Peak Tempo | | Femperature | Numbe | r of Reflow Cyc | cles |
| Matte Tin (Sn) - annealed | | CU Alloy NA | | NA | | 0 C | | 30 | 30 seco | | 3 | | |
| omments | | | | | | | | | | | | | |
| | | | | | | | | | | | | | |
| or more information regardin | g material compositio | n please refer to | page 3 | | | | | | | | | | |

| RoHS Material Composition Declaration | | | | Declaration Type * | Detailed | | | | | | |
|--|---|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS Directive 2011/65/EU | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). | | | | | | | | | | |
| cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the | henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies | RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform | ce of its products with European Union membe | ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of | | | | | | |
| RoHS Declaration * 1 - Item(s) | does not contain RoHS restricted substa | ances per the definitio | on above | Supplier Acceptance | * Accepted | | | | | | |
| Exemption: If the declared item does not con applicable exemptions. | ntain RoHS restricted substances per | the definition above | except for defined RoHS exempti | ons, then select the corresponding response i | n the RoHS Declaration above and choose all | | | | | | |
| Exemption List Version | EL-2011/534/EU | | | | | | | | | | |
| Declaration Signature | | | | | | | | | | | |
| Instructions: Complete all of the required fin Requester) and click on Submit Form to have | elds on all pages of this form. Select the form returned to the Requester | he "Accepted" on th | e Supplier Acceptance drop-down | . This will display the signature area. Digital | lly sign the declaration (if required by the | | | | | | |
| Supplier Digital Signature Ra | stislav Drska | Le | | | | | | | | | |

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level | Substance | CAS | Exempt | Weight | Unit of Measure |
|----------------------|----------|-----------------|----------|--|--------------|--------|-------------|-----------------|
| Case | 10330.0 | mg | Supplier | Fiber Glass (SiO2) | 65997-17-3 | | 3615.5 | mg |
| | | - | Supplier | РВТ | 26062-94-2 | | 6714.4995 | mg |
| Case Lid | 6690.0 | mg | Supplier | Fiber Glass (SiO2) | 65997-17-3 | | 2341.5 | mg |
| | | | Supplier | PBT | 26062-94-2 | | 4348.5 | mg |
| DBC | 17490.0 | mg | Supplier | Aluminum Trioxide (Al2O3) | 1344-28-1 | | 7293.3301 | mg |
| | | | В | Nickel (Ni) | 7440-02-0 | | 34.98 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 10161.6895 | mg |
| Die | 219.105 | mg | Supplier | Silicon (Si) | 7440-21-3 | | 219.105 | mg |
| Glue | 410.0 | mg | Supplier | 2,3-epoxypropyl-trimethoxysilan | 2530-83-8 | | 41 | mg |
| | | | Supplier | Miscellaneous | Trade Secret | | 41 | mg |
| | | | Supplier | Silica Crystalline (SiO2) | 14808-60-7 | | 328 | mg |
| Heat Sink | 123450.0 | mg | В | Nickel (Ni) | 7440-02-0 | | 1913.475 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 121536.5234 | mg |
| NTC | 10.0 | mg | Supplier | Silver (Ag) | 7440-22-4 | | 0.0979 | mg |
| | | | Supplier | Tin (Sn) | 7440-31-5 | | 0.02 | mg |
| | | | Supplier | Nickel Oxide (NiO) | 1313-99-1 | | 3.9169 | mg |
| | | | Supplier | Palladium (Pd) | 7440-05-3 | | 0.0999 | mg |
| | | | В | Nickel (Ni) | 7440-02-0 | | 0.01 | mg |
| | | | Supplier | Cobalt Oxide (Co3O4) | 1308-06-1 | | 0.3997 | mg |
| | | | Supplier | Manganese Tetraoxide (Mn3O4) | 1317-35-7 | | 5.4556 | mg |
| Silicone Gel | 8400.0 | mg | Supplier | Silica, [(ethenyldimethylsilyl)oxy]- and [(trimethylsilyl)oxy]- modified | 68988-89-6 | | 2520 | mg |
| | | | Supplier | Silica Crystalline (SiO2) | 14808-60-7 | | 5880 | mg |
| Solder Paste | 5040.0 | mg | Supplier | Silver (Ag) | 7440-22-4 | | 327.6 | mg |
| | | | Supplier | Tin (Sn) | 7440-31-5 | | 4712.3999 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | -151.2004 | mg |
| Terminal | 3540.0 | mg | Supplier | Silicon (Si) | 7440-21-3 | | 9.558 | mg |
| | | | В | Nickel (Ni) | 7440-02-0 | | 47.79 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 3481.7671 | mg |
| | | | Supplier | Phosphorus (P) | 7723-14-0 | | 0.885 | mg |
| Wire Bond - Al | 39.0 | mg | Supplier | Aluminum (Al) | 7429-90-5 | | 39 | mg |